Hangzhou Multi-Color Optoelectronics Co., Ltd

MULTI-COLOR SPECIFICATION FOR SMD 3535WSA

MC-S3535WSA

FEATURES: • Size (mm):3.5×3.5

• Surface not reflective

• High Luminous Intensity (mcd)

Red:650-900 Green: 1250-1800 Blue: 280-480

High reliability

• Good UV resistance performance

• High Waterproofness(IPX6, IPX7, IPX8)

• Pb-free Reflow soldering Application

• RoHS Compliant

1. SPECIFICATIONS



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1.1 Absolute Maximum Ratings (Ta=25°C)

Item	Cymbol	Ab	Unit			
item	Symbol	Red	Green	Blue	Offic	
Forward Current	I_{F}	30	30	30	mA	
Pulse Forward Current	I_{FP}	100	100	100	mA	
Reverse Voltage	V_R	5	5	5	V	
Power dissipation	P _D	62.4	99.9	100.5	mW	
Operating Temperature	T _{opr}	-30 to +85	-30 to +85	-30 to +85	°C	
Storage Temperature	T _{stg}	-40 to +100	-40 to +100	-40 to +100	°C	

^{*} $I_{\mbox{\tiny FP}}$ conditions with pulse width $\leq 10 \mbox{ms}$ and duty cycle $\leq 10 \mbox{\%}$.

1.2 Optical and Electrical Characteristics (Ta=25°C)

Item Symbol	Cymhol Conditi	Condition			Red Gre		ВІ	Blue	
	Condition	Min	Max	Min	Max	Min	Max	Unit	
Forward Voltage	$V_{\scriptscriptstyle F}$	I _F =20mA	1.75	2.45	2.75	3.65	2.75	3.65	V
Reverse Current	I_R	V _R =5V		1		1		1	μΑ
	,	I - 20m A	617	627	515	535	460	480	
Wavelength	λ_D $I_F=20mA$		3nm p	er Bin	3nm į	oer Bin	3nm p	er Bin	nm
Talanai	т	I - 20m A	650	900	1250	1800	280	480	
Luminous Intensity I_V $I_{F}=2$		I _F =20mA Typ.		750	Typ. 1500		Тур. 350		mcd

^{*} A: Not Reflective Surface.

^{*} Each Bin: $I_V(Max):I_V(Min) \le 1.2$.

^{*} Tolerance of measurements of the Forward Voltage is ± 0.05 V.

^{*} Tolerance of measurements of the Luminous Intensity is $\pm 5\%$.

^{*} Tolerance of measurements of the Wavelength is ± 0.5 nm.



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2.1 Test Items and Results

Test Item	Standard Test Method	Test Conditions	Test Duratio n	Units Failed/Tes ted
Resistance to Soldering Heat (Reflow Soldering)	JEITA ED-4701 300 301	Tsld=260°C,10sec. Precondition:30°C 70%RH,168hrs	2times	0/100
Temperature Cycle		-65°C~150°C 15min. 15min. (30min./cycle)	200cycl es	0/100
Temperature Cycle	JEITA ED-4701 100 105	-40°C~25°C~100°C~25°C 30min. 5min. 30min. 5min	100cycl es	0/100
Moisture Resistance (Cyclic)	JEITA ED-4701 200 203	25°C~65°C~-10°C 90%RH, 24hr per cycle	10cycle s	0/100
High Temperature Storage	JEITA ED-4701 200 201	Ta=100°C	500hrs	0/100
Temperature Humidity Storage		Ta=85°C,RH=85%	500hrs	0/100
Low Temperature Storage	JEITA ED-4701 200 202	Ta=-40°C	500hrs	0/100
Room Temperature Operating Life		Ta=25°C, I _F =15mA	1000hrs	0/10
Temperature Humidity Operating Life		$Ta=85$ °C,RH= 85 % $I_F=15$ mA	500hrs	0/10
Low Temperature Operating Life		Ta=-30°C, I _F =15mA	1000hrs	0/10
IPX6	IEC60529:2001	Distance of nozzle to specimen :3m Water Flow:100L/min (Remark: The sample was powered on during the test)	3min	0/512
IPX7	IEC60529:2001	Water Depth:1m (Remark: LED should be powered on during the test)	30min	0/512
IPX8	IEC60529:2001	Soaking Depth:2m (Remark: The sample was powered off during the test)	60min	0/512

NOTES:

 $\label{lem:measurements} \mbox{ Measurements are performed after allowing the LEDs to return to room temperature.}$

2.2 Criteria for Judging Damage

Thom	Cymphol	Test Conditions	Criteria for Judgement		
Item	Symbol	rest Conditions	Min.	Max.	
Forward Voltage	V_{F}	$I_F = 20mA$	-	U.S.L.×1.1	
Reverse Current	I_R	V _R =5V	-	U.S.L.×2.0	
Luminous Intensity	I_{V}	I _F =20mA	L.S.L. ×0.8	-	

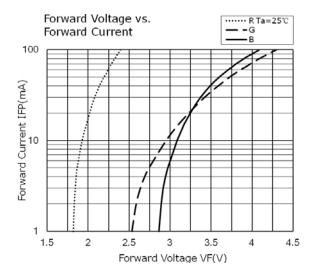
U.S.L.: Upper Standard Level

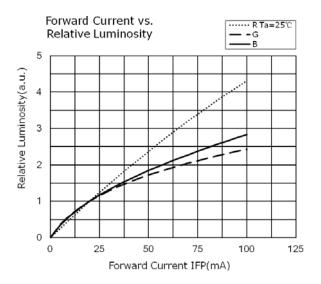
L.S.L.: Lower Standard Level

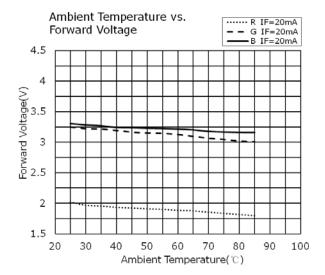
3. TYPICAL ELECTRICAL CHARACTERISTICS CURVES

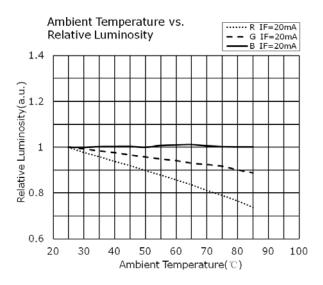
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All characteristics shown are for reference only and are not guaranteed.









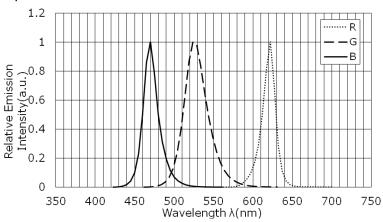


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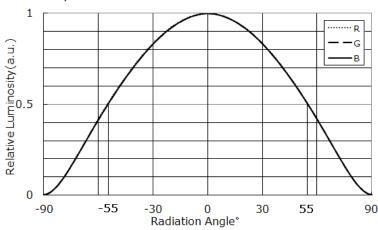
4. TYPICAL OPTICAL CHARACTERISTICS CURVES

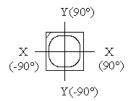
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Spectrum

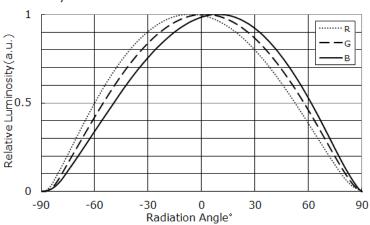


Directivity X-X





Directivity Y-Y



- * Monochromatic Relative Intensity Profile was controlled $\leq \pm 10\%$
- * RGB Relative Intensity Profile was controlled ≤±5%

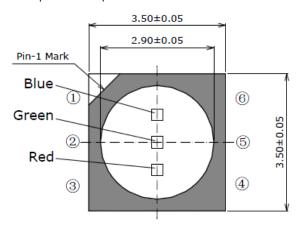
(Unit: mm, Tolerance: ±0.2)

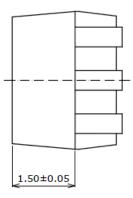


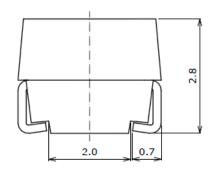
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5. OUTLINE DIMENSIONS AND MATERIALS

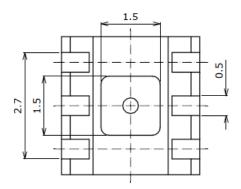
This product complies with RoHS Directive.

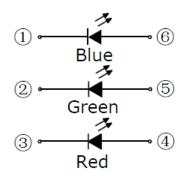






Item	Description		
Package Materials	White Heat-Resistant Polymer		
Package Upper Surface	DI I		
Color	Black		
Encapsulating Resin	Francis (Mith different)		
Materials	Epoxy Resin(With diffuser)		
Electrodes Materials	Ag-plated Copper Alloy		





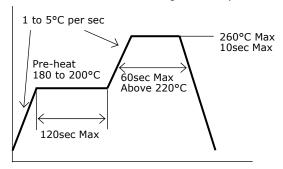
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6. SOLDERING

• Recommended Reflow Soldering Condition(Lead-free Solder)



• Recommended Hand Soldering Condition

Temperature	350°C Max		
Soldering Time	3sec Max		

- * Reflow soldering must not be performed more than twice. Hand soldering must not be performed more than once.
- * Avoid rapid cooling. Ramp down the temperature gradually from the peak temperature.
- * Nitrogen reflow soldering is recommended. Air flow soldering conditions can cause optical degradation, caused by heat and/or atmosphere.
- * Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-heat soldering iron should be used.

It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

- * When soldering, do not apply stress to the LED while the LED is hot.
- * This product can differ in optical characteristics depending on the number of reflow cycles.

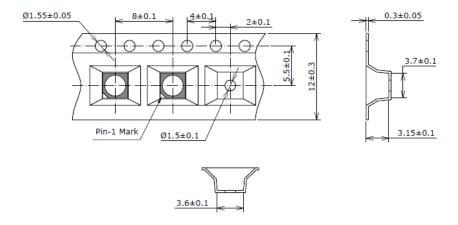
In a single display, only LEDs with same number of reflow cycles should be used regardless of the application type, such as rental and/or permanent installations.

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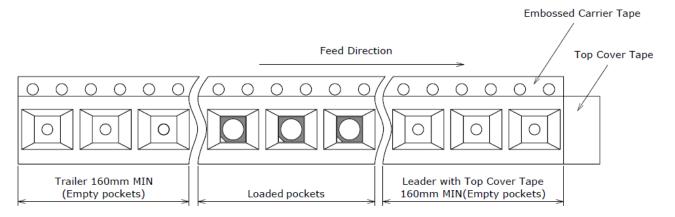
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7. TAPE AND REEL DIMENSIONS

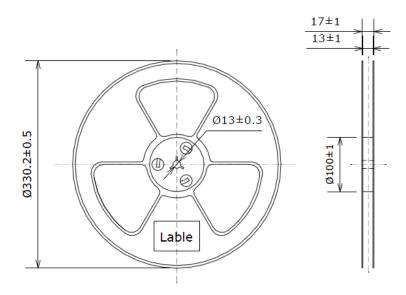
Tape: (Unit: mm)



Trailer and Leader:



Reel:



Quantity per reel=2500pcs

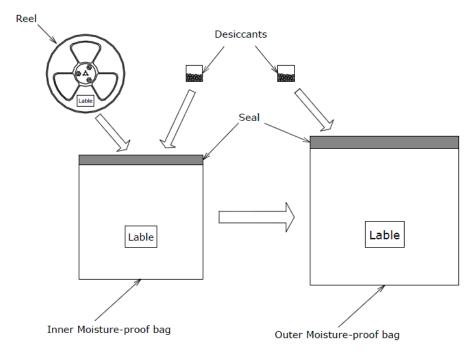


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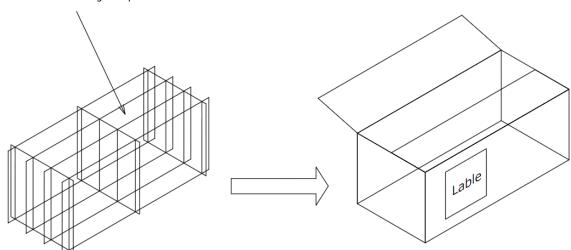
8. PACKAGING - TAPE & REEL

Reels are shipped with desiccants in heat-sealed inner moisture-proof bags.

Inner moisture-proof bags are shipped with desiccants in heat-sealed outer moisture-proof bags.



Outer moisture-proof bags are packed in cardboard boxes with corrugated partitions.



- * The Label shows: P/O NO., TYPE, QTY, IV, VF, WLD,BATCH CODE.
- * Products shipped on tape and reel are packed in moisture-proof bag. They are shipped in cardboard boxes to protect them from external forces during transportation.
- * Do not drop or shock the box. It may damage the products.
- * Do not expose to water, the box is not water-resistant.
- * Using an original packaging material or equivalent in transit is recommended.

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MOISTURE PROOF PACKAGE

- When moisture is absorbed into the SMT package it may vaporize and expand during soldering. There is a possibility that this can cause exfoliation of the contacts and damage the optical characteristics of the LEDs. For this reason, the moisture proof package is used to keep moisture to a minimum in the package.
- The moisture proof package is made absorbent material (silica gel desiccants) is inserted into the aluminium moisture proof bag.
- The silica gel desiccants change from blue to red if moisture had penetrated bags.

10.STORAGE CONDITIONS

• Storage Conditions

Before opening the package:

The LEDs should be kept at 30℃ or less and 90%RH or less.

The LEDs should be used within a year.

When storing the LEDs, moisture proof packaging with absorbent material (silica gel desiccants) is recommended.

• After opening the package:

The LEDs should be soldered Within 168 hours (7 days) after opening the package. if unused LEDs remain, they should be stored in the moisture proof packages, such as sealed containers with packages of moisture absorbent material (silica gel desiccants). It is also recommended to return the LEDs to the original moisture proof bag and to reseal the moisture proof bag again.

• If the moisture absorbent material (silica gel desiccants) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following condition.

Baking treatment: more than 24 hours at 65℃

• Please avoid rapid transitions in ambient temperature, especially in high humidity environments where condensation can occur.

11.STATIC ELECTRICITY

• Static electricity or surge voltage damages the LEDs.

It is recommended that a wrist band or an anti-electrostatic glove be used when handing the LEDs.

• All devices equipment and machinery must be properly grounded. It is recommended that precautions be taken against surge voltage to the equipment that mounts the LEDs.